

- Designed for Complementary Use with BDW23, BDW23A, BDW23B and BDW23C
- 50 W at 25°C Case Temperature
- 6 A Continuous Collector Current
- Minimum h_{FE} of 750 at 2 A, 3 V

TO-220 PACKAGE (TOP VIEW) B 1 C 2 E 3

Pin 2 is in electrical contact with the mounting base.

MDTRACA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT		
	BDW24		-45		
Collector-base voltage (I _F = 0)	BDW24A	W	-60	V	
Collector base voltage (IE - 0)	BDW24B	V _{CBO}	-80	V	
	BDW24C		-100		
	BDW24		-45		
Collector emitter voltage (I = 0)	BDW24A	W	-60	V	
Collector-emitter voltage (I _B = 0)	BDW24B	V _{CEO}	-80		
	BDW24C		-100		
Emitter-base voltage			-5	V	
Continuous collector current	I _C	-6	Α		
Continuous base current			-0.2	Α	
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)			50	W	
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)			2	W	
Operating junction temperature range			-65 to +150	°C	
Storage temperature range	T _{stg}	-65 to +150	°C		
Operating free-air temperature range	T _A	-65 to +150	°C		

NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.4 W/°C.

2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.



electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS				MIN	TYP	MAX	UNIT
V _{(BR)CEO}	Collector-emitter breakdown voltage	I _C = -100 mA	I _B = 0	(see Note 3)	BDW24 BDW24A BDW24B BDW24C	-45 -60 -80 -100			V
I _{CEO}	Collector-emitter cut-off current		$I_{B} = 0$ $I_{B} = 0$ $I_{B} = 0$ $I_{B} = 0$		BDW24 BDW24A BDW24B BDW24C			-0.5 -0.5 -0.5 -0.5	mA
І _{СВО}	Collector cut-off current	~ -	_		BDW24 BDW24A BDW24B BDW24C			-0.2 -0.2 -0.2 -0.2	mA
I _{EBO}	Emitter cut-off current	V _{EB} = -5 V	I _C = 0					-2	mA
h _{FE}	Forward current transfer ratio	$V_{CE} = -3 V$ $V_{CE} = -3 V$ $V_{CE} = -3 V$	$I_C = -2 A$	(see Notes 3 and	4)	1000 750 100		20000	
V _{CE(sat)}	Collector-emitter saturation voltage	$I_B = -8 \text{ mA}$ $I_B = -60 \text{ mA}$	-	(see Notes 3 and	14)			-2 -3	٧
V _{BE(sat)}	Base-emitter saturation voltage	I _B = -8 mA	I _C = -2 A	(see Notes 3 and	14)			-2.5	٧
V _{BE(on)}	Base-emitter voltage	$V_{CE} = -3 V$ $V_{CE} = -3 V$	$I_C = -1 A$ $I_C = -6 A$	(see Notes 3 and	14)			-2.5 -3	٧
V _{EC}	Parallel diode forward voltage	I _E = -2 A	I _B = 0					-1.8	V

NOTES: 3. These parameters must be measured using pulse techniques, t_p = 300 μ s, duty cycle \leq 2%.

thermal characteristics

	PARAMETER			MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.5	°C/W
$R_{\theta JA}$	Junction to free air thermal resistance			62.5	°C/W

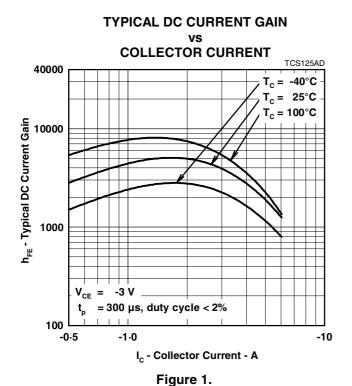
resistive-load-switching characteristics at 25°C case temperature

	PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t _{on}	Turn-on time	I _C = -3 A	$I_{B(on)} = -12 \text{ mA}$	$I_{B(off)} = 12 \text{ mA}$		1		μs
t _{off}	Turn-off time	$V_{BE(off)} = 4.5 V$	$R_L = 10 \Omega$	$t_p = 20 \ \mu s, \ dc \le 2\%$		5		μs

[†] Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

^{4.} These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

TYPICAL CHARACTERISTICS



COLLECTOR-EMITTER SATURATION VOLTAGE

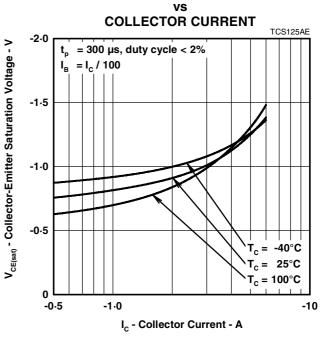
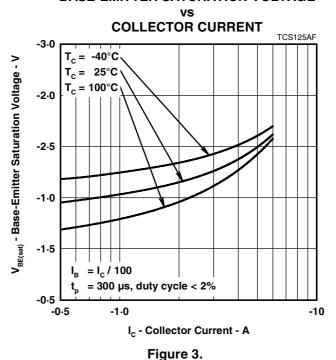


Figure 2.

BASE-EMITTER SATURATION VOLTAGE



PRODUCT INFORMATION

MAXIMUM SAFE OPERATING REGIONS

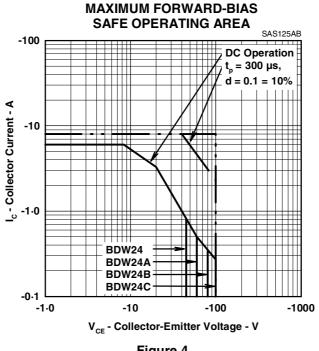


Figure 4.

THERMAL INFORMATION

MAXIMUM POWER DISSIPATION

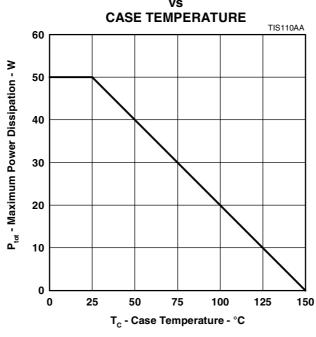


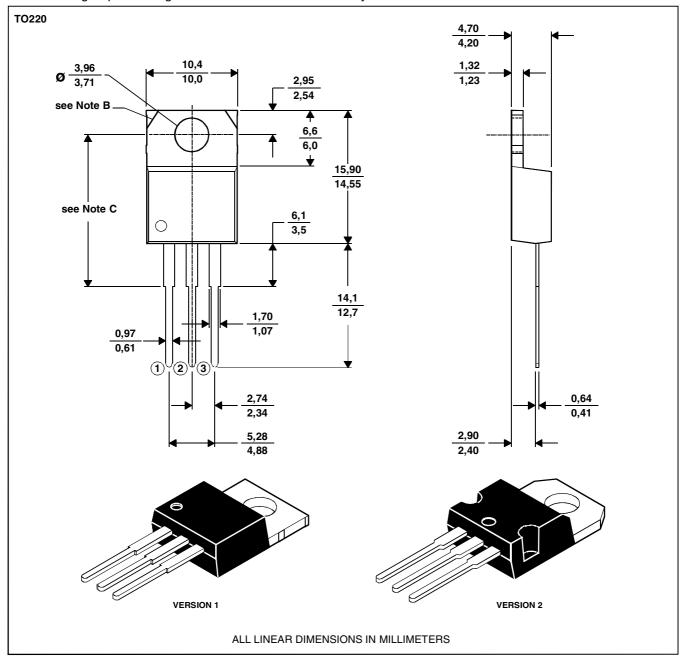
Figure 5.

MECHANICAL DATA

TO-220

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTES: A. The centre pin is in electrical contact with the mounting tab.

- B. Mounting tab corner profile according to package version.
- C. Typical fixing hole centre stand off height according to package version.

Version 1, 18.0 mm. Version 2, 17.6 mm.

MDXXBE